VSSAF512

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Vishay General Semiconductor

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	5.0 A			
V _{RRM}	120 V			
I _{FSM}	100 A			
V_F at I_F = 5.0 A (125 °C)	0.62 V			
T _J max.	150 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.95 mm
- · Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 gualified available - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	VSSAF512	UNIT	
Device marking code		V512		
Maximum repetitive peak reverse voltage	V _{RRM}	120	V	
Maximum average forward rectified current	I _{F(AV)} ⁽¹⁾ 2		^	
	I _{F(AV)} ⁽²⁾	5.0	— A	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	100	A	
Operating junction and storage temperature range	T _J , T _{STG}	-40 to +150	°C	

Notes

⁽¹⁾ Free air, mounted on recommended copper pad area

(2) Mounted on 30 mm x 30 mm pad area

Document Number: 87611

RoHS COMPLIANT

HALOGEN FREE

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.5 A	- T _A = 25 °C	V _F ⁽¹⁾	0.60	-	V
	I _F = 5.0 A			0.77	0.88	
	I _F = 2.5 A	- T _A = 125 °C		0.53	-	
	I _F = 5.0 A			0.62	0.72	
Reverse current	$\lambda = 00 \lambda$	$V_{R} = 90 V = \frac{T_{A} = 25 °C}{T_{A} = 125 °C}$	I _R ⁽²⁾	0.01	-	mA
	v _R = 90 v	T _A = 125 °C		1.7	-	
	$V_{-120}V_{-120}$	T _A = 25 °C T _A = 125 °C		-	0.4	
	v _R = 120 v	T _A = 125 °C		4	15	
Typical junction capacitance	4.0 V, 1 MH	4.0 V, 1 MHz		360	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL	VSSAF512	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾⁽²⁾	115	°C/W	
	R _{0JM} ⁽³⁾	12	0/11	

Notes

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance R_{0JA} - junction to ambient, R_{0JM} - junction to mount

⁽²⁾ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/DT_J < 1/R_{\theta JA}$

⁽³⁾ Mounted on 30 mm x 30 mm pad area

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSSAF512-M3/H	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF512-M3/I	0.032	I	14 000	13" diameter plastic tape and reel	
VSSAF512HM3/H ⁽¹⁾	0.032	Н	3500	7" diameter plastic tape and reel	
VSSAF512HM3/I ⁽¹⁾	0.032	ļ	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

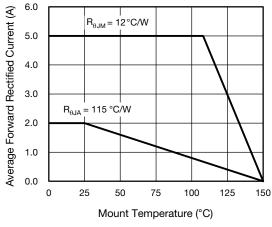


Fig. 1 - Maximum Forward Current Derating Curve

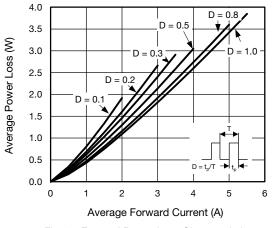


Fig. 2 - Forward Power Loss Characteristics

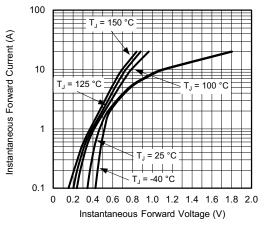
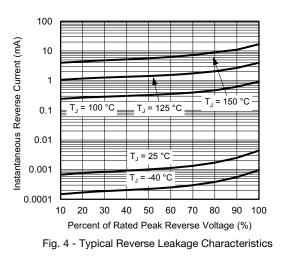
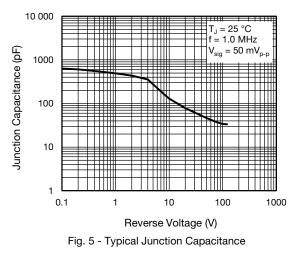


Fig. 3 - Typical Instantaneous Forward Characteristics





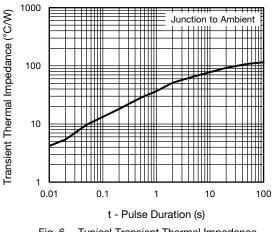


Fig. 6 - Typical Transient Thermal Impedance

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3

Document Number: 87611

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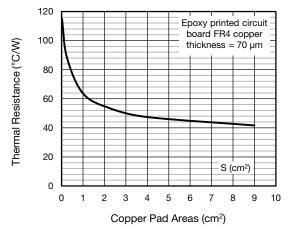
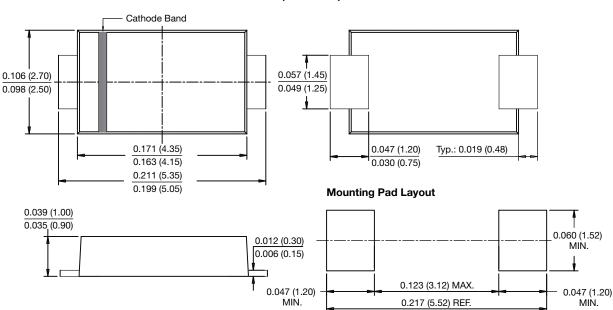


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



SlimSMA (DO-221AC)



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